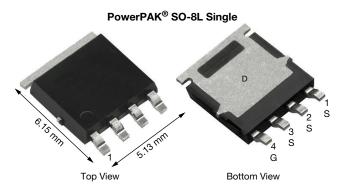
SQJ420EP

www.vishay.com

Vishay Siliconix

Automotive N-Channel 40 V (D-S) 175 °C MOSFET



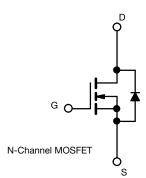
PRODUCT SUMMARY	
V _{DS} (V)	40
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0100
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.0120
I _D (A)	30
Configuration	Single

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>



COMPLIANT HALOGEN



ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJ420EP (for detailed order number please see <u>www.vishay.com/doc?79771</u>)

ABSOLUTE MAXIMUM RATINGS (T	_C = 25 °C, unles	s otherwise noted	l)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage	n-source voltage V _{DS}		40	V
Gate-source voltage		V _{GS}	± 20	
Continuous drain current	$T_C = 25 \ ^\circ C \ ^a$	I.	30	
	T _C = 125 °C	۱ _D	26.8	
Continuous source current (diode conduction) ^a		I _S	30	А
Pulsed drain current ^b	I _{DM}	110		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	28	
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	39	mJ
Maximum and dissisting b	T _C = 25 °C	PD	45	w
Maximum power dissipation ^b	T _C = 125 °C	125 °C 15		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) of	l, e		260	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction to ambient	PCB mount ^c	R _{thJA}	70	°C/W
Junction to case (drain)		R _{thJC}	3.3	0/10

Notes

- a. Package limited
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

S22-0060-Rev. B, 24-Jan-2022

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SQJ420EP

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		<u>.</u>					•
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	V _{DS} = V _{GS} , I _D = 250 μA		2.0	2.5	V
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 125 °C	-	-	50	
		V _{GS} = 0 V	V _{DS} = 40 V, T _J = 175 °C	-	-	150	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	30	-	-	Α
	- ()	V _{GS} = 10 V	I _D = 9.7 A	-	0.0082	0.0100	
		V _{GS} = 4.5 V	I _D = 8 A	-	0.0098	0.0120	Ω
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 9.7 A, T _J = 125 °C	-	-	0.0166	
		V _{GS} = 10 V	I _D = 9.7 A, T _{.1} = 175 °C	-	-	0.0204	
Forward transconductance ^b	g _{fs}		= 15 V, I _D = 9.7 A	_	68	_	s
Dynamic ^b	510				1	L	
Input capacitance	C _{iss}			-	1427	1860	
Output capacitance	C _{oss}	$V_{GS} = 0 V$	V _{DS} = 25 V, f = 1 MHz	-	193	260	pF
Reverse transfer capacitance	C _{rss}			-	71	95	
Total gate charge ^c	Qq			-	27	41	
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V	V _{DS} = 20 V, I _D = 11.3 A	_	4.6	_	nC
Gate-drain charge ^c	Q _{gd}			_	4.6	_	
Gate resistance	R _g	f = 1 MHz		0.65	1.36	2.10	Ω
Turn-on delay time ^c	t _{d(on)}			-	10	15	
Rise time ^c	t _r	,			4	10	ns
Turn-off delay time ^c	t _{d(off)}	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 13.3 \Omega$ $I_{D} \cong 1.5 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$		-	25	40	
Fall time ^c	t _f	-			5	10	
Source-Drain Diode Ratings and Charac	•			-		10	I
Pulsed current ^a	I _{SM}			-	-	110	Α
Forward voltage	V _{SD}	le le	= 7 A, V _{GS} = 0	-	0.79	1.2	V
Body diode reverse recovery time	vsD t _{rr}			-	28	60	ns
Body diode reverse recovery charge	Q _{rr}	-		-	25	50	nC
Reverse recovery fall time	ta	- I _F = 5	A, di/dt = 100 A/μs	-	18	-	_
Reverse recovery rise time	t _b	1		-	10	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.8	-	Α

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

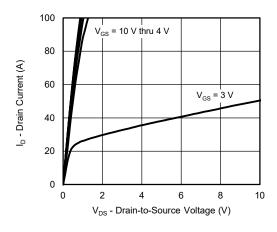
b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

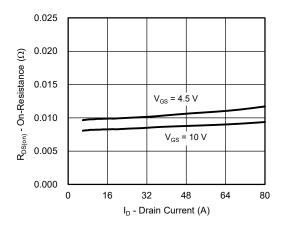
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



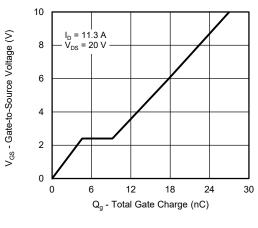
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



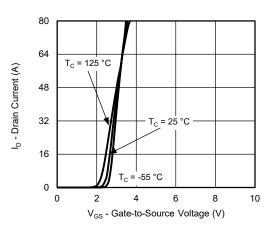
Output Characteristics



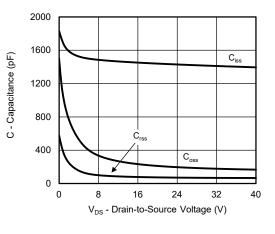
On-Resistance vs. Drain Current



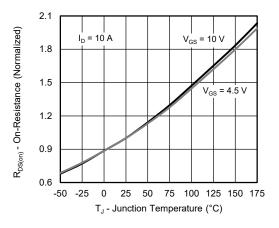
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

S22-0060-Rev. B, 24-Jan-2022

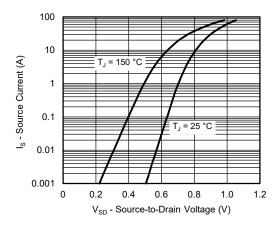
3

Document Number: 75546

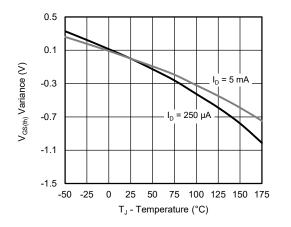
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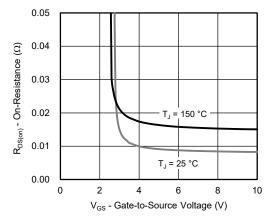
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



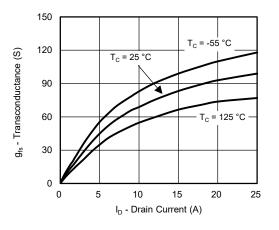
Source Drain Diode Forward Voltage



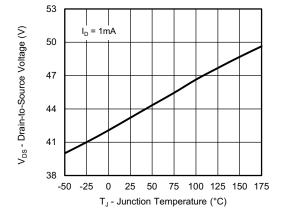




On-Resistance vs. Gate-to Source Voltage



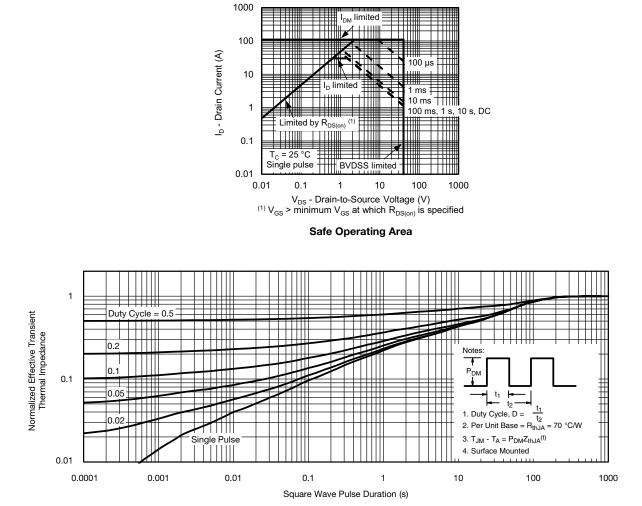
Transconductance



Drain Source Breakdown vs. Junction Temperature



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

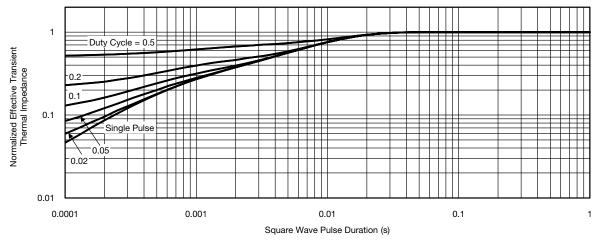


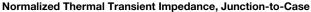
Normalized Thermal Transient Impedance, Junction-to-Ambient



Document Number: 75546

TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





Note

• The characteristics shown in the two graphs

S22-0060-Rev. B, 24-Jan-2022

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

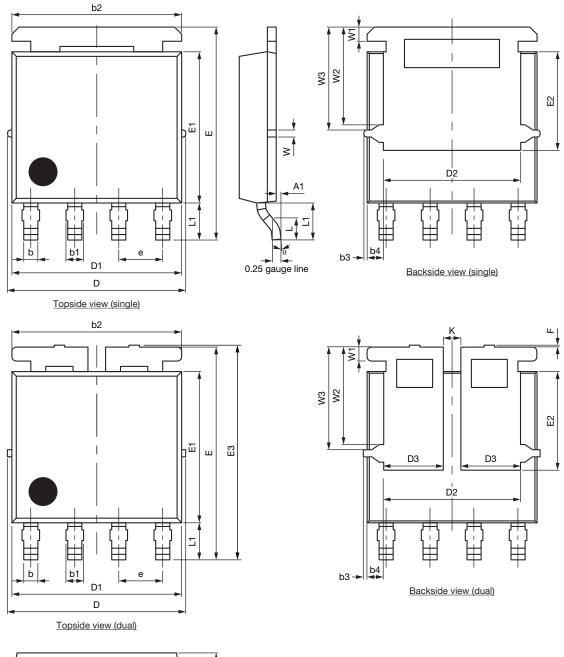
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

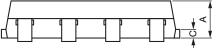
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75546.









Package Information



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DIM		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.00	1.07	1.14	0.039	0.042	0.045	
A1	0.00	-	0.127	0.00	-	0.005	
b	0.33	0.41	0.48	0.013	0.016	0.019	
b1	0.44	0.51	0.58	0.017	0.020	0.023	
b2	4.80	4.90	5.00	0.189	0.193	0.197	
b3		0.094			0.004		
b4		0.47			0.019		
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	5.00	5.13	5.25	0.197	0.202	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.86	3.96	4.06	0.152	0.156	0.160	
D3	1.63	1.73	1.83	0.064	0.068	0.072	
е		1.27 BSC		0.050 BSC			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	4.27	4.37	4.47	0.168	0.172	0.176	
E2	2.75	2.85	2.95	0.108	0.112	0.116	
E3	6.05	6.22	6.40	0.238	0.245	0.252	
F	-	-	0.15	-	-	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
К		0.51		0.020			
W		0.23		0.009			
W1	0.41		0.016				
W2		2.82		0.111			
W3		2.96		0.117			
θ	0°	-	10°	0°	-	10°	

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK[®] SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

Revision: 07-Feb-12



Vishay

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